

**HAT1021R** 

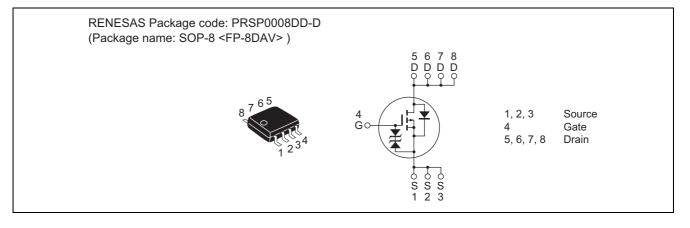
Silicon P Channel Power MOS FET High Speed Power Switching

> REJ03G1144-0600 (Previous: ADE-208-475D) Rev.6.00 Sep 07, 2005

## Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

## Outline





# **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Value	Unit
Drain to source voltage	V <sub>DSS</sub>	-20	V
Gate to source voltage	V <sub>GSS</sub>	±10	V
Drain current	ID	-5.5	A
Drain peak current	I <sub>D (pulse)</sub> Note 1	-44	A
Body-drain diode reverse drain current	I <sub>DR</sub>	-5.5	A
Channel dissipation	Pch Note 2	2.5	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. When using the glass epoxy board (FR4 40  $\times$  40  $\times$  1.6 mm), PW  $\leq$  10 s

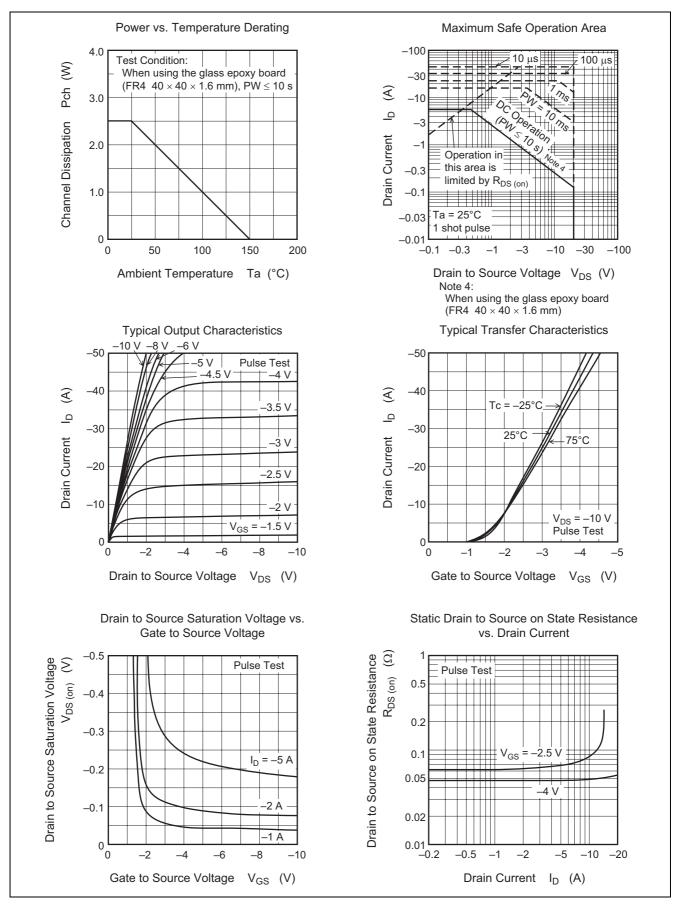
# **Electrical Characteristics**

						(Ta = 25°C)
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	-20		—	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±10		—	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	—		±10	μA	$V_{GS} = \pm 8 V$ , $V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	—		-10	μA	$V_{DS} = -20 V, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS (off)</sub>	-0.5		-1.5	V	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$
Static drain to source on state resistance	R <sub>DS (on)</sub>	—	0.048	0.060	Ω	$I_D = -3 \text{ A}, V_{GS} = -4 \text{ V}^{\text{Note 3}}$
	R <sub>DS (on)</sub>	—	0.065	0.085	Ω	$I_D = -3 \text{ A}, V_{GS} = -2.5 \text{ V}^{\text{Note 3}}$
Forward transfer admittance	y <sub>fs</sub>	6	9.5	—	S	$I_D = -3 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note 3}}$
Input capacitance	Ciss	—	1200	—	pF	$V_{DS} = -10 V$
Output capacitance	Coss	—	630	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	200	—	pF	f = 1 MHz
Turn-on delay time	t <sub>d (on)</sub>	—	20	—	ns	$V_{GS} = -4 V, I_D = -3 A,$
Rise time	t <sub>r</sub>	—	120	—	ns	$V_{DD} \cong -10 \text{ V}$
Turn-off delay time	t <sub>d (off)</sub>	—	175	—	ns	
Fall time	t <sub>f</sub>		140		ns	
Body-drain diode forward voltage	V <sub>DF</sub>		-0.9	-1.4	V	$I_F = -5.5 \text{ A}, V_{GS} = 0^{\text{Note 3}}$
Body-drain diode reverse recovery time	t <sub>rr</sub>	—	65	—	ns	I <sub>F</sub> = –5.5 A, V <sub>GS</sub> = 0
						di <sub>F</sub> /dt = 20 A/μs

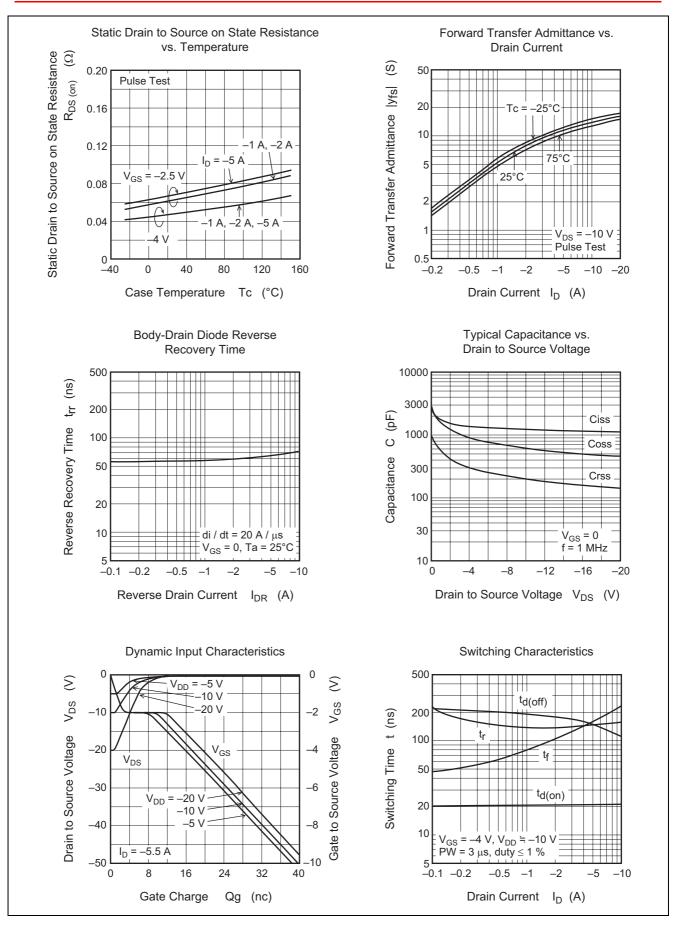
Note: 3. Pulse test



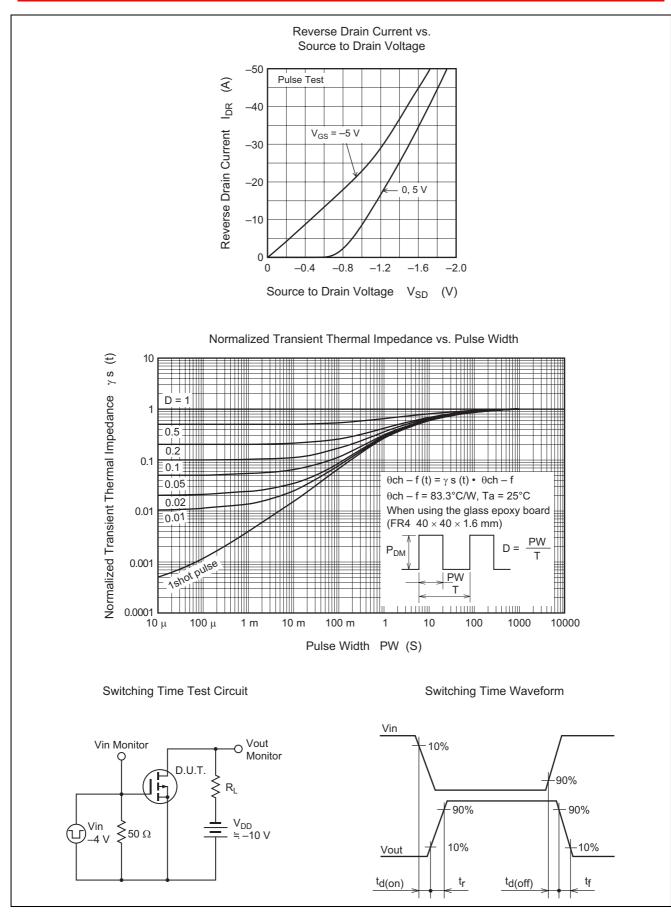
## **Main Characteristics**





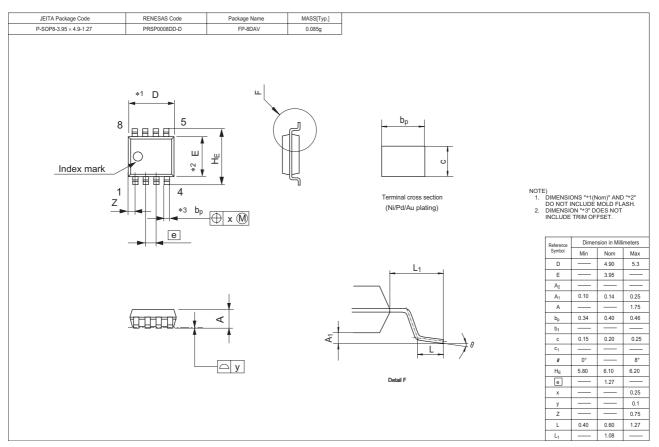








# **Package Dimensions**



# **Ordering Information**

Part Name	Quantity	Shipping Container
HAT1021R-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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